

# POWER LINE COMMUNICATION AND Sub-GHz WIRELESS COMMUNICATION SOLUTIONS

Brochure



## POWER LINE COMMUNICATION AND Sub-GHz WIRELESS COMMUNICATION SOLUTIONS INTERCONNECTING IOT INFRASTRUCTURE



Renesas supplies wired and wireless communication ICs that are used in applications such as smart meters and other IoT applications. Power line communication (PLC) modem ICs utilize existing power lines for communication. Renesas narrowband power line communication solutions that employ the frequency band up to 500kHz are widely used in PLC smart meters, which are achieving ever broader adoption in Europe in particular.

At the same time, the adoption of Renesas wireless solutions employing Sub-GHz band wireless communication technology that uses wireless radio signals at frequencies below 1GHz is expanding in applications such as flow meters and wireless sensor networks. Renesas offers PLC and Sub-GHz solutions conforming to international standards. By offering an array of solutions with features suitable for multiple applications, Renesas is contributing to the realization of a robust IoT infrastructure.

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## **Example Applications**

## Energy & Environment





- Smart meters
- PV solar systems
- Energy harvesting

## **Smart Buildings**





- BEMS
- HVAC
- Fire and safety

## Smart Lighting





- Smart streetlights
- Illumination
- Digital signage

## **Sensor Networks**





## **Device-to-device communication networks**



- Unit load systemsStructural health monitoring
- Environmental monitoring

- Multifunction printers
- Underwater pump motor monitoring
- Cellular antenna monitoring

## **PLC Solutions**

PLC is a technology that uses existing power lines as the communication medium. Using the power grid as a communication network makes it possible to build out systems inexpensively and quickly. Either AC power lines or DC power lines can be employed as the communication medium.

Renesas offers narrowband PLC modem IC products with integrated high-performance DSPs and CPUs that support a variety of power line communication protocols. They employ orthogonal frequency-division multiplexing (OFDM) to deliver highly reliable, robust communication. Renesas PLC modem ICs support high data transfer speeds up to 1Mbps over distances of a kilometer or more.



## **Product Selection Guide**

Renesas offers two PLC modem IC products. Select the one that best matches your application and the scale of your network.

Product	Features	
R9A06G037	This PLC modem IC complies with international power line communication standards (G3-PLC, PRIME, and Meters and More). Suitable for large-scale mesh networks with multi-hop support.	
R9A06G061	19A06G061 This compact and powerful PLC modem IC is designed specifically for peer-to-peer (P2P) networks. It delivers high communication speeds up to 1Mbps.	

#### Comparison of Product Features

	R9A06G037	R9A06G061
Data rate	Max. 280kbps	Max. 1Mbps
Communication distance	1km or more	1km or more
Network type	Multi-hop (mesh or tree)	P2P (star or bus)

### Product Application Fields

The R9A06G037 is intended for large-scale networks, while the R9A06G061 is suitable for networks requiring high-speed communication and networks with a simple topology.



## R9A06G037

The R9A06G037 is a PLC modem IC that complies with international power line communication standards (G3-PLC, PRIME, and Meters and More). The R9A06G037 supports multi-hop networks and mesh networks with excellent redundancy, making it suitable for large-scale network applications such as smart meters.

### **Applications**

• Smart meters • PV solar systems • BEMS • HVAC • Fire & Safety • Smart streetlights

### **Features**

- High-performance DSP (max. operating frequency: 276MHz, IRAM: 128KB, DRAM: 128KB)
- MCU (ARM<sup>®</sup> Cortex<sup>™</sup>-M3, max. operating frequency: 138MHz, RAM: 512KB)
- Integrated analog frontend (AFE) circuit
- External I/O: UART (2 channels), CSI (2 channels), IIC, serial ROM interface (single/dual/quad), PWM (2 channels)

### **Supported Standards**

- G3-PLC (CENELEC-A, CENELEC-B, FCC, ARIB)
- PRIME v1.3.6
- PRIME v1.4
- Meters and More

### **Evaluation Environment**

Three evaluation kits optimized for AC power lines or DC power lines are available for R9A06G037 evaluation and development work. Circuit diagrams, parts lists, and Gerber data are available for each evaluation kit.

Evaluation Kit	Product No.	Description
CPX3 Evaluation Kit J70D1	RTK0EE0003D01002BJ	AC power line communication evaluation kit
CPX3 Evaluation Kit J80D1	RTK0EE0007D01001BJ	DC power line communication evaluation kit
CPX3 Evaluation Kit HYBRID	Y-G-HYBRID-PLC-RF	PLC&RF Hybrid communication evaluation kit

Evaluation Kit	J70D1	J80D1	Y-G-HYBRID-PLC-RF
Туре	For AC power lines	For DC power lines	Support PLC&RF Hybrid communication
Supported voltage range	100V to 230V AC	16V to 48V DC	100V to 230V AC
Mounted MCU	RX631	RX651	RX651
Note	—	Audio board for voice communication included	—
Exterior view		Contraction of the second	

Evaluation tools and sample applications that work with the evaluation kits are also available. Refer to page 7 for information on this software.

• Integrated regulator: Input 3.3V, output 1.1V

- Power supply voltage: 3.3V
- Package: 64-pin QFN, 9mm × 9mm, 0.5mm pin pitch
- Operating temperature range: -40 to +85°C





## R9A06G061

The R9A06G061 is a compact and powerful PLC modem IC designed specifically for peer-to-peer (P2P) networks. In addition to supporting high communication speeds up to 1Mbps over distances of a kilometer or more, the R9A06G061 provides improved drive capacity in direct-drive configurations to enable an expanded range of applications for DC power systems. This makes it possible to connect 200 or more devices at once. Optimized analog peripheral functions help to reduce the number of external components, enabling lower system cost and more compact size.

### **Applications**

- PV solar systems
- BEMS
- HVAC

- Fire & Safety Smart streetlights
  - Illumination

- Signage
- Multifunction printers
- Underwater pumps

## Cellular antenna monitoring

- **Features**
- High-performance DSP (max. operating frequency: 276MHz, IRAM: 128KB, DRAM: 128KB)
- MCU (ARM<sup>®</sup> Cortex<sup>™</sup>-M0+, max. operating frequency: 92MHz, RAM: 32KB)
- Integrated analog frontend (AFE) circuit
- External I/O: UART (1 channel), SPIs (1 channel), serial flash interface (single/ dual), clock output
- **Supported Standards** P2P-PLC (FCC, ARIB)



### **Evaluation Environment**

Two evaluation kits optimized for AC power lines or DC power lines are available for R9A06G061 evaluation and development work. Circuit diagrams, parts lists, and Gerber data are available for each evaluation kit.

Evaluation Kit	Product No.	Description
CPX4 Evaluation Kit M01D01	RTK0EE0009D01001BJ	DC power line communication evaluation kit
CPX4 Evaluation Kit M02D02	RTK0EE0009D02001BJ	AC power line communication evaluation kit

Evaluation Kit	M01D01	M02D02
Туре	For DC power lines	For AC power lines
Supported voltage range	16V to 48V DC	100V to 230V AC
Mounted MCU	RX651	RX651
Exterior view		

Evaluation tools and sample applications that work with the evaluation kits are also available. Refer to page 7 for information on this software.



 Integrated regulator: Input 3.3V, output 1.15V DC-to-DC converter • Power supply voltage: 3.3V

- Package: 40-pin QFN, 6mm × 6mm, 0.5mm pin pitch
- Operating temperature range: R9A06G061GNP#AA0: -40 to +85°C R9A06G061GNP#AAA: -40 to +105°C





### **Software**

### **Software for PLC Solutions**

A sample application software is available that runs on the evaluation kits. The sample application is provided as both source code and in project file format, so customers can make use of them when developing or debugging their own applications. Each sample application package includes a PLC communication software stack.

There are two types of sample application: A two-chip solution that operates the PLC modem IC from the Host MCU, and a one-chip solution that implements the User Application in the PLC modem IC itself.



2chip solution configuration

1chip solution configuration

### **Communication Software Stack for PLC Solutions**

PLC communication software stacks and sample application software are available for various standards. Renesas also offers communication software for P2P network.

Communication Software Stack	Supported Network Type	Supported PLC Modem IC
G3-PLC communication software		
PRIME v1.3.6 communication software	Multi her returnle	D04000007
PRIME v1.4 communication software	Multi-hop networks	R9A06G037
Meters and More communication software		
F3AL (Renesas proprietary communication software for the R9A06G037)	P2P networks	R9A06G037
P2P-PLC (Communication software for the R9A06G061)	PZP Hetworks	R9A06G061

### **Development Support Tools for PLC Solutions**

Tools are available that run on the evaluation kits and enable evaluation of communication performance and network configurations. Using these tools, customers can efficiently evaluate power line communication conditions of virtual venues or perform on-site inspections, monitor communication quality, analyze errors, and more.



### SimpleMAC GUI

Tool for the evaluation of communication performance G3-PLC network evaluation tool

- Packet transmission and reception
- Measuring communication quality
- Display of data on reception statistics



### **G3-PLC Network Communicator**

- Building networks as a coordinator
- Multi-hop communication
- Display of network topology



### **PRIME Base Node Tool**

• Functions as a PRIME base node to enable confirmation and evaluation of the functionality of service nodes developed by customers.

Evaluation Tool	Supported PLC Modem IC	Supported Evaluation Kits
SimpleMAC CIII	R9A06G037	J70D2, J80D1, Y-G-HYBRID-PLC-RF
SimpleMAC GUI	R9A06G061	M01D01, M02D02
G3-PLC Network Communicator	R9A06G037	J70D2, Y-G-HYBRID-PLC-RF
PRIME Base Node Tool	R9A06G037	J70D2, Y-G-HYBRID-PLC-RF

## PLC Communication Module Configuration



Example of PLC Communication Module Configuration for AC Power Lines

### Example of PLC Communication Module Configuration for DC Power Lines



### **Recommended Renesas Devices**

Block	Product Category	Recommended Product
Control MCU	MCU	RX Family
		R9A06G037
	PLC modem IC	R9A06G061
Communication module	Line driver	ISL15102
Communication module	AC/DC regulator	RAA2230214
	DC/DC regulator	ISL85415
	Serial flash	AT25SF



## **PLC&RF Hybrid Solution**

Renesas offers a PLC&RF hybrid solution that combines a PLC solution and a Sub-GHz wireless communication solution. The PLC&RF hybrid solution provides Sub-GHz wireless communication coverage in areas where communication cannot be implemented using PLC alone, thereby enhancing network reliability and expandability.

The PLC&RF hybrid solution brings together two different communication technologies in a way that makes it easy for users to make use of them as a single network.



### Applications

Smart meters

BEMS
 Smart streetlights

### **Supported Standards**

- G3-PLC Hybrid (CENELEC-A, FCC and ARIB)
- PRIME Hybrid (PRIME v1.4 MultiPHY)



### PLC&RF Hybrid Communication Module Configuration Example



### **Recommended Renesas Devices**

Block	Product Category	Recommended Product
Control MCU	MCU	RX Family
	PLC modem IC	R9A06G037
	Sub-GHz wireless communication IC	RAA604S00
Communication and da	Line driver	ISL15102
Communication module	AC/DC regulator	RAA2230214
	DC/DC regulator	ISL854102
	LDO	ISL80510

### **Evaluation Environment**

An evaluation kit is available for evaluation and development work using the PLC&RF hybrid solution. Circuit diagrams, parts lists, and Gerber data for the evaluation kit are also available.

Evaluation Kit	PLC&RF Hybrid Evaluation Kit	
Product No.	Y-G-HYBRID-PLC-RF	
Туре	For AC power lines	
Supported voltage range	100V to 230V AC	
	PLC modem IC	R9A06G037
Mounted devices	Sub-GHz wireless communication IC	RAA604S00
	Host MCU	RX651
Note		
Exterior view		

Y-G-HYBRID-PLC-RF allows seamless evaluation of communication performance for PLC&RF Hybrid, PLC only, and RF only.



PLC&RF communication configuration







PLC communication configuration

RF communication configuration

### **Development Support Tools**

The following development support tools are available.

PLC8	Supported Evaluation Kit	
PHY Communicator	PLC and RF PHY communication performance evaluation tool	
G3-PLC Network Communicator	Combining PLC and RF hybrid network evaluation tool	
Combining PLC and AP hydro network evaluation tool		Y-G-HYBRID-PLC-RF/Y-G-HYBRID-PLC-RF-JP

### **Communication Software Stacks and Sample Application Software**

Available software for PLC&RF hybrid communication includes the communication software stacks listed below and sample application software that runs on the PLC&RF hybrid evaluation kit.

Communication Software Stacks	Supported Networks	Supported Modem ICs	
Communication software supporting G3-PLC Hybrid	Multi han naturalia	R9A06G037 RAA604S00	
Communication software supporting PRIME Hybrid (PRIME v1.4 MultiPHY)	Multi-hop networks		

# **Sub-GHz Wi-SUN Wireless Communication Solutions**

Sub-GHz band wireless communication is a technology that uses wireless radio signals at frequencies below 1GHz to transfer data.

Utilizing the Sub-GHz band provides advantages over Wi-Fi or Bluetooth Low Energy (BLE) communication, which use the 2.4GHz band, in terms of coverage over longer distances, ability to bend around obstacles, and low interference with other radio signals. It is therefore an ideal communication technology for a "smart society" in which all sorts of things, indoors and out, are interconnected, and where the goal is to provide a variety of services in an energy-efficient manner.



Note: Varies according to the communication distance and the environment in which the technology is used.

### **Product Selection Guide**

### Renesas Sub-GHz Wireless Communication Devices for "High Performance" and "Design Simplicity"

Renesas offers discrete Sub-GHz wireless communication ICs and MCUs with an integrated Sub-GHz wireless communication IC. Customers can select the one that best meets their system requirements.

	Product	Product Category	Supported Standard	Modulation	Features
	R9A06G062	Wireless communication IC		FSK / OFDM	OFDM modulation enables high-speed communication. Conformant with Wi-SUN FAN 1.1 protocol.
<b>NEW</b> F	RAA604S00	wreless communication ic	- IEEE 802.15.4-2020	FSK	Integrated RF peripheral components help keep product costs down. Delivers low power consumption.
	RX65W-A	MCU with integrated wireless communication IC		FSK / OFDM	A single-chip solution combining RX CPU and wireless communication LSI conformant with Wi-SUN FAN1.1.
	RL78/G1H			FSK	A single-chip solution combining RL78 CPU and low-power wireless communication LSI.

## R9A06G062

The R9A06G062 is conformant with the IEEE 802.15.4-2020 and Wi-SUN FAN 1.1 protocols and provides Sub-GHz wireless communication using OFDM and FSK modulation. OFDM modulation is suitable for IoT devices and delivers high-speed, robust communication. FSK modulation maintains compatibility with the FAN 1.0 protocol, making it indispensable for IoT communication.

### **Applications**

- Smart meters
- ters Environmental monitoring
- Structural health monitoring
- Digital signage



### **Features**

- RF frequency range: 863MHz to 928MHz
- Data rate: SUN FSK, max. 200 kbps SUN OFDM, max. 2,400 kbps
- 32-bit timer function
- Operating voltage: 2.7V to 3.6V
- Operating temperature range: -40 to +85°C
- Package: 40-pin HVQFN (6mm × 6mm, 0.5mm pitch)

### Maximum Tx output power: +15dBm (FSK) +11dBm (0FDM)

- Minimum reception sensitivity: -109dBm (FSK/50kbps, PER<10%)
  - -95dBm (0FDM/2,400kbps, PER<10%)

### **Evaluation Environment**

This kit has received Japanese construction design certification, FCC certification for North America, and the CE marking indicating compliance with EU specifications, so developers can start using it to evaluate Sub-GHz wireless communication performance right away. It can also be used to evaluate systems employing Wi-SUN FAN 1.1–certified stacks obtained elsewhere and as a development kit for customers' own Wi-SUN FAN systems.

Product No.: RTK0EE0013D10001BJ (FCC certified) RTK0EE0013D10002BJ (CE certified) RTK0EE0013D10003BJ (construction design certified in Japan) Manufactured by Renesas Electronics Corporation.



## RAA604S00

The RAA604S00 is a Sub-GHz wireless communication IC that delivers current consumption of 5.8mA (3.3V) in RF reception standby mode, among the lowest in the industry. The RF peripheral components necessary for connecting a wireless antenna are integrated into the IC, simplifying the design of the antenna connection circuit and reducing the number of external components needed for reduced overall product cost. Built-in hardware support for the IEEE 802.15.4-2020 standard reduces the load on the CPU during wireless communication.

### **Applications**

Smart meters

**Features** 

Smart lighting

Sensor networks

• RF frequency range: 863MHz to 928MHz

Smart buildings

- Data rate: 2GFSK, max. 300 kbps
- 32-bit timer function
- Operating voltage: 1.8V to 3.6V

• Operating temperature range: -40 to +85°C

RENESAS

RAA604500

- Package: 32-pin HVQFN (5mm × 5mm, 0.5mm pitch)
- Maximum Tx output power: +15dBm
- Minimum reception sensitivity: -107dBm (FSK/50kbps, BER<0.1%)

### **Evaluation Environment**

This kit has received Japanese construction design certification and the CE marking indicating compliance with EU specifications, so developers can start using it to evaluate Sub-GHz wireless communication performance right away. It can also be used to evaluate systems employing Wi-SUN FAN–certified stacks obtained elsewhere and as a development kit for customers' own Wi-SUN FAN systems.



Product No.: MB-RX604S-02 (RX651), manufactured by Tessera Technology Inc.

### RX65W-A

The new RX65W-A is a Sub-GHz wireless microcontroller that integrates an RXv2 core, large RAM, security functions, and RF LSI supporting OFDM and FSK. It can realize Wi-SUN FAN1.1 Border Router and Router Node as a single-chip solution, contributing to downsizing of wireless communication modules and reduction of product cost.

Please contact Renesas sales office for board design and evaluation environment.

### **Applications**

- Smart meters
- Environmental monitoring
- Structural health monitoring
- Digital signage



### **Features**

- CPU: RXv2 core, up to 120MHz
- On-chip memory: SRAM:640KB, Code flash:2MB, data flash:32KB
- RF frequency range: 863MHz to 928MHz
- Data rate: SUN FSK, max. 200 kbps
  - SUN OFDM, max. 2,400 kbps
- 32-bit timer function

- Operating temperature range: –40 to +85°C
- Package: 145 pin TFBGA (8mm × 8mm, 0.5mm pitch)
- Maximum Tx output power: +15dBm (FSK)

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+11dBm (OFDM)
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Minimum reception sensitivity: -109dBm (FSK/50kbps, PER<10%)

-95dBm (OFDM/2,400kbps, PER<10%)

Operating voltage: 2.7V to 3.6V

## **RL78/G1H**

The RL78/G1H MCU is a single-chip Sub-GHz wireless solution that incorporates an ultra-low power RL78 CPU core and an integrated Sub-GHz wireless communication IC. It can be mounted as a single-chip solution in combination with a Renesas high-quality certified Wi-SUN stack (see page 12), or a separately obtained protocol stack package and a user application, reducing the mounting area associated with the control MCU and contributing to reduced product cost overall. The ultra-low power consumption of the RL78 core, one of its key features, makes the RL78/G1H ideal for battery-driven devices.

### **Applications**

- Smart meters
  Smart buildings
  Smart lighting
- · Sensor networks, battery-driven devices



### **Features**

- CPU: RL78 core, up to 32MHz
- On-chip memory: Code flash: 256KB to 512KB, SRAM: 24KB to 48KB, data flash: 8KB
- RF frequency range: 863MHz to 928MHz
- Data rate: 2GFSK, max. 300 kbps
- Operating voltage: 1.8V to 3.6V
- Operating temperature range: -40 to +85°C
- Package: 64-pin HVQFN (9mm × 9mm, 0.5mm pitch)

- Timers: 16-bit timer (channels) × 9, watchdog timer (channel) × 1, 12-bit interval timer (channel) × 1
- Analog function: 10-bit A/D converter (channels) × 6
- On-chip oscillator frequencies: High-speed: 32, 24, 16, 12, 8, 4, 1MHz Low-speed: 15kHz
- Other: RTC, power-on reset, low-voltage detection
- Maximum Tx output power: +15dBm
- Minimum reception sensitivity: -107dBm (FSK/50kbps, BER<0.1%)

### **Evaluation Environment**

This kit has received Japanese construction design certification, so developers can start using it to evaluate Sub-GHz wireless communication performance right away. It can also be used to evaluate systems employing Wi-SUN FAN–certified stacks obtained elsewhere and as a development kit for customers' own Wi-SUN FAN systems.



Product No.: TK-RLG1H+SB2, manufactured by Tessera Technology Inc.

## Software

### Sub-GHz/Wi-SUN FAN Protocol Stack Packages

Software is available from Renesas for Sub-GHz wireless communication solutions that implements the Wi-SUN profile wireless communication protocol, based on the IEEE 802.15.4-2020 international standard. The Wi-SUN FAN IP stack is conformant with the FAN protocol established by the Wi-SUN Alliance, the body that promotes Wi-SUN standards. Customers can select the package that best meets the requirements of their application.



	RF Driver Package		FAN Stack Package		
	RF Characteristic Evaluation Program	Simple MAC	Wi-SUN FAN 1.0 stack (for Router Only)	Wi-SUN FAN 1.0 stack (for Router & Border Router)	Wi-SUN FAN 1.1 stack (for Router & Border Router)
МСИ	RL78/G1H RX651+RAA604S00 RX65W-A RX65N+R9A06G062	RL78/G1H RX651+RAA604S00 RX65W-A RX65N+R9A06G062	RL78/G1H	RX651+RAA604S00	RX65W-A RX65N+R9A06G062
Compliant standards	IEEE802.15.4-2020	IEEE802.15.4-2020	IEEE802.15.4-2020	IEEE802.15.4-2020	IEEE802.15.4-2020
Wi-SUN Profile	Wi-SUN PHY Profile	Wi-SUN PHY Profile	Wi-SUN FAN Profile	Wi-SUN FAN Profile	Wi-SUN FAN Profile
Connection form	1 to 1 (Peer to Peer)	1 to N Broadcast	Multi-hop (up to 24 hops)	Multi-hop (up to 24 hops)	Multi-hop (up to 24 hops)
Network scale	Small network	Small network	Large network	Large network	Large network
Software provision form	RF driver (Source code) Sample Application (Source code) Project file	RF driver (Source code) Sample Application (Source code) Project file	Stack (library) Sample application (source code) Project file	Stack (library) Sample application (source code) Project file	Stack (library) Sample application (source code) Project file
RTOS	Unnecessary	Unnecessary	FreeRTOS	FreeRTOS	FreeRTOS
Compatible compiler	CA78K0R, CC-RL, CC-RX	CA78K0R, CC-RL, CC-RX	IAR	CC-RX	CC-RX
Supported integrated environment	CS+, e² studio	CS+, e² studio	IAR	e <sup>2</sup> studio	e² studio

### **RF Driver**

This RF driver is an OS-independent program that provides PHY layer level API to control Renesas Sub-GHz communication LSI. It enables wireless communication in compliance with IEEE802.15.4-2020.

Additionally, it includes transmission control functions such as a carrier sense function to avoid transmission collisions with other wireless stations, and regulatory controls for total transmission time and transmission pause time. This makes it easier to design and certify wireless equipment in accordance with the radio laws of various countries.

### Simple MAC: Serial Command Sample Program

This product includes a sample program for setting MAC addresses and transmission and reception of broadcast and unicast frames. Using the sample program and RF driver together makes it easy to build a 1-to-N network.

### IP Stack: Wi-SUN FAN (Field Area Network)

Wi-SUN FAN is an open, standards-based communication protocol that enables wide-area, long-distance communication while avoiding interference and collisions. It is a system with multi-hop (multi-stage relay) and mesh functionality, making it exceptional even among low-power wide-area (LPWA) technologies for its ability to enable stable and robust data connections over long distances and with coverage of dead zones.



Wi-SUN FAN has been deployed in millions of smart meters worldwide and has great potential also for smart cities and smart grids for applications such as smart homes, building management, and lighting systems.

The Renesas Wi-SUN FAN IP stacks support the IP base functionality required by Wi-SUN FAN, including 6LoWPAN, IPv6, ICMPv6, RPL, and UDP. For secure authentication, both IEEE 802.1X authentication used by wireless LANs and access security based on EAP-TLS are supported. The IP stacks have passed interoperability testing by the Wi-SUN Alliance and are Wi-SUN FAN certified. In addition, they are officially certified by the Wi-SUN Alliance as a test bed unit (TBU), so developers can use them with confidence when designing wireless network systems.



### **Development Support Tools for Sub-GHz Wireless Communication Solutions**

These tools enable developers to easily evaluate communication for each protocol stack by making use of sample programs and a graphical user interface. Analyzing wireless communication system status can be difficult because the strength of wireless signals often varies due to environmental conditions and obstructions. The packet capture GUI tool can display wireless communication data in visual format and show analysis results for each protocol.



### **Renesas Partner Vendors**

RF board setting configuration technology is necessary when developing control boards for communication devices. Sub-GHz wireless modules equipped with wireless communication ICs (RAA604S00 and RL78/G1H), antennas, and peripheral circuits are available from Renesas partner vendors. Customers can incorporate these boards into their mass-produced products. These products simplify the process of developing and mass producing products with Sub-GHz support for customers who are unfamiliar with RF board setting configuration technology.



Vizmonet Pte. Ltd.

This company develops, manufactures, and sells Sub-GHz wireless communication modules mounted with the RL78/G1H.





### **Tessera Technology Inc.**

This company develops, manufactures, and sells evaluation environments for Sub-GHz wireless communication.

## **Sub-GHz Communication Module Configuration**

RX65N+R9A06G062 Sub-GHz Wireless Communication Module Example



### RX651+RAA604S00 Sub-GHz Wireless Communication Module Example



### RX65W-A Sub-GHz Wireless Communication Module Example



## RL78/G1H Sub-GHz Wireless Communication Module Example



Block	Product Category	Recommended Product	
	Wireless communication IC	R9A06G062, RAA604S00	
	Wireless communication IC control MCU	RX65N, RX651	
	MCU with integrated wireless communication IC	RL78/G1H, RX65W-A (NEW)	
Communication module	RF switch	F2977	
	RF amplifier	F1471	
	DC-to-DC converter	ISL85418	
	Power regulator	ISL9113, RAA211412, ISL80505, ISL9122	

\* SAW Filter and RF Amplifier: Regional optional parts



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